

Surface mounting technology - Part 2: Transportation and storage conditions of surface mounting devices (SMD) - Application guide

EESTI STANDARDI EESSÕNA

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**Surface mounting technology - Part 2: Transportation and
storage conditions of surface mounting devices (SMD) -
Application guide
(IEC 61760-2:2021)**

Technique du montage en surface - Partie 2: Conditions de
transport et de stockage des composants pour montage en
surface (CMS) - Guide d'application
(IEC 61760-2:2021)

Oberflächenmontagetechnik - Teil 2: Transport- und
Lagerungsbedingungen von oberflächenmontierbaren
Bauelementen (SMD) - Anwendungsleitfaden
(IEC 61760-2:2021)

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European foreword

The text of document 91/1666/CDV, future edition 3 of IEC 61760-2, prepared by IEC/TC 91 “Electronics assembly technology” was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 61760-2:2021.

The following dates are fixed:

- latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2022-05-20
- latest date by which the national standards conflicting with the document have to be withdrawn (dow) 2024-08-20

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In the official version, for Bibliography, the following notes have to be added for the standards indicated:

IEC 60286-3	NOTE Harmonized as EN IEC 60286-3
IEC 60286-4	NOTE Harmonized as EN 60286-4
IEC 60286-5	NOTE Harmonized as EN IEC 60286-5
IEC 60286-6	NOTE Harmonized as EN 60286-6
IEC 60749 (series)	NOTE Harmonized as EN 60749 (series)
IEC 60749-20-1:2019	NOTE Harmonized as EN IEC 60749-20-1:— ¹ (not modified)
IEC 61340-5-1	NOTE Harmonized as EN 61340-5-1
IEC 61760-4:2015	NOTE Harmonized as EN 61760-4:2015 (not modified)
IEC 62435 (series)	NOTE Harmonized as EN IEC 62435 (series)

¹ To be published. Stage at the time of publication: prEN IEC 60749-20-1:2019.

Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60721-3-1	2018	Classification of environmental conditions -EN IEC 60721-3-1 Part 3-1: Classification of groups of environmental parameters and their severities - Storage	EN IEC 60721-3-1	2018
IEC 60721-3-2	2018	Classification of environmental conditions -EN IEC 60721-3-2 Part 3-2: Classification of groups of environmental parameters and their severities - Transportation and handling	EN IEC 60721-3-2	2018

INTERNATIONAL STANDARD

NORME INTERNATIONALE



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Draft	Report on voting
91/1666/CDV	91/1708/RVC

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

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